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NSBA114EDXV6T1, NSBA114EDXV6T5

Preferred Devices

Dual Bias Resistor Transistors

PNP Silicon Surface Mount Transistors with Monolithic Bias Resistor Network

The BRT (Bias Resistor Transistor) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base-emitter resistor. These digital transistors are designed to replace a single device and its external resistor bias network. The BRT eliminates these individual components by integrating them into a single device. In the NSBA114EDXV6T1 series, two BRT devices are housed in the SOT-563 package which is ideal for low-power surface mount applications where board space is at a premium.

- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- Available in 8 mm, 7 inch Tape and Reel
- Lead Free Solder Plating

MAXIMUM RATINGS

($T_A = 25^\circ\text{C}$ unless otherwise noted, common for Q_1 and Q_2)

| Rating | Symbol | Value | Unit |
|---------------------------|-----------|-------|------|
| Collector-Base Voltage | V_{CBO} | -50 | Vdc |
| Collector-Emitter Voltage | V_{CEO} | -50 | Vdc |
| Collector Current | I_C | -100 | mAdc |

THERMAL CHARACTERISTICS

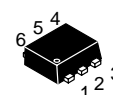
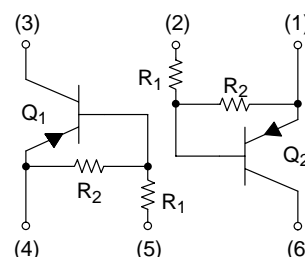
| Characteristic (One Junction Heated) | Symbol | Max | Unit |
|---|-----------------|-----------------|---------------------------|
| Total Device Dissipation $T_A = 25^\circ\text{C}$ | P_D | 357 (Note 1) | mW |
| Derate above 25°C | | 2.9 (Note 1) | mW/ $^\circ\text{C}$ |
| Thermal Resistance Junction-to-Ambient | $R_{\theta JA}$ | 350 (Note 1) | $^\circ\text{C}/\text{W}$ |
| Characteristic (Both Junctions Heated) | Symbol | Max | Unit |
| Total Device Dissipation $T_A = 25^\circ\text{C}$ | P_D | 500 (Note 1) | mW |
| Derate above 25°C | | 4.0 (Note 1) | mW/ $^\circ\text{C}$ |
| Thermal Resistance Junction-to-Ambient | $R_{\theta JA}$ | 250 (Note 1) | $^\circ\text{C}/\text{W}$ |
| Junction and Storage Temperature Range | T_J, T_{stg} | -55 to +150 | $^\circ\text{C}$ |

1. FR-4 @ Minimum Pad



ON Semiconductor®

<http://onsemi.com>



SOT-563
CASE 463A
PLASTIC

MARKING DIAGRAM



xx = Specific Device Code
(see table on page 2)
D = Date Code

ORDERING INFORMATION

| Device | Package | Shipping |
|----------------|---------|--------------------------------|
| NSBA114EDXV6T1 | SOT-563 | 4 mm pitch 4000/Tape & Reel |
| NSBA114EDXV6T5 | SOT-563 | 2 mm pitch 8000/Tape & Reel |

DEVICE MARKING INFORMATION

See specific marking information in the device marking table on page 2 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

NSBA114EDXV6T1, NSBA114EDXV6T5

DEVICE MARKING AND RESISTOR VALUES

| Device | Package | Marking | R1 (kΩ) | R2 (kΩ) |
|--------------------------|---------|---------|---------|---------|
| NSBA114EDXV6T1 | SOT-563 | 0A | 10 | 10 |
| NSBA124EDXV6T1 | SOT-563 | 0B | 22 | 22 |
| NSBA144EDXV6T1 | SOT-563 | 0C | 47 | 47 |
| NSBA114YDXV6T1 | SOT-563 | 0D | 10 | 47 |
| NSBA114TDXV6T1 (Notes 2) | SOT-563 | 0E | 10 | ∞ |
| NSBA143TDXV6T1 (Notes 2) | SOT-563 | 0F | 4.7 | ∞ |
| NSBA113EDXV6T1 (Notes 2) | SOT-563 | 0G | 1.0 | 1.0 |
| NSBA123EDXV6T1 (Notes 2) | SOT-563 | 0H | 2.2 | 2.2 |
| NSBA143EDXV6T1 (Notes 2) | SOT-563 | 0J | 4.7 | 4.7 |
| NSBA143ZDXV6T1 (Notes 2) | SOT-563 | 0K | 4.7 | 47 |
| NSBA124XDXV6T1 (Notes 2) | SOT-563 | 0L | 22 | 47 |
| NSBA123JDXV6T1 (Notes 2) | SOT-563 | 0M | 2.2 | 47 |
| NSBA115EDXV6T1 (Notes 2) | SOT-563 | 0N | 100 | 100 |
| NSBA144WDXV6T1 (Notes 2) | SOT-563 | 0P | 47 | 22 |

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted, common for Q₁ and Q₂)

| Characteristic | Symbol | Min | Typ | Max | Unit |
|---|----------------|-----|-----|-------|------|
| OFF CHARACTERISTICS | | | | | |
| Collector-Base Cutoff Current ($V_{CB} = -50\text{ V}$, $I_E = 0$) | I_{CBO} | - | - | -100 | nAdc |
| Collector-Emitter Cutoff Current ($V_{CE} = -50\text{ V}$, $I_B = 0$) | I_{CEO} | - | - | -500 | nAdc |
| Emitter-Base Cutoff Current ($V_{EB} = -6.0\text{ V}$, $I_C = 0$) | I_{EBO} | - | - | -0.5 | mAdc |
| | NSBA114EDXV6T1 | - | - | -0.2 | |
| | NSBA124EDXV6T1 | - | - | -0.1 | |
| | NSBA144EDXV6T1 | - | - | -0.2 | |
| | NSBA114YDXV6T1 | - | - | -0.9 | |
| | NSBA114TDXV6T1 | - | - | -1.9 | |
| | NSBA143TDXV6T1 | - | - | -4.3 | |
| | NSBA113EDXV6T1 | - | - | -2.3 | |
| | NSBA123EDXV6T1 | - | - | -1.5 | |
| | NSBA143EDXV6T1 | - | - | -0.18 | |
| | NSBA143ZDXV6T1 | - | - | -0.13 | |
| | NSBA124XDXV6T1 | - | - | -0.2 | |
| | NSBA123JDXV6T1 | - | - | -0.05 | |
| | NSBA115EDXV6T1 | - | - | -0.13 | |
| | NSBA144WDXV6T1 | - | - | - | |
| Collector-Base Breakdown Voltage ($I_C = -10\ \mu\text{A}$, $I_E = 0$) | $V_{(BR)CBO}$ | -50 | - | - | Vdc |
| Collector-Emitter Breakdown Voltage (Note 3) ($I_C = -2.0\text{ mA}$, $I_B = 0$) | $V_{(BR)CEO}$ | -50 | - | - | Vdc |
| ON CHARACTERISTICS (Note 3) | | | | | |
| Collector-Emitter Saturation Voltage ($I_C = -10\text{ mA}$, $I_E = -0.3\text{ mA}$) ($I_C = -10\text{ mA}$, $I_B = -5\text{ mA}$) NSBA113EDXV6T1/NSBA123EDXV6T1 ($I_C = -10\text{ mA}$, $I_B = -1\text{ mA}$) NSBA114TDXV6T1/NSBA143TDXV6T1 NSBA143EDXV6T1/NSBA143ZDXV6T1/NSBA124XDXV6T1 | $V_{CE(sat)}$ | - | - | -0.25 | Vdc |

2. New resistor combinations. Updated curves to follow in subsequent data sheets.

3. Pulse Test: Pulse Width < 300 μs, Duty Cycle < 2.0%

NSBA114EDXV6T1, NSBA114EDXV6T5

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted, common for Q₁ and Q₂) (continued)

| Characteristic | Symbol | Min | Typ | Max | Unit | |
|---|--|--------------------------------|--|---|--|-----|
| ON CHARACTERISTICS (Note 3) (continued) | | | | | | |
| DC Current Gain (V _{CE} = -10 V, I _C = -5.0 mA) | NSBA114EDXV6T1 NSBA124EDXV6T1 NSBA144EDXV6T1 NSBA114YDXV6T1 NSBA114TDXV6T1 NSBA143TDXV6T1 NSBA113EDXV6T1 NSBA123EDXV6T1 NSBA143EDXV6T1 NSBA143ZDXV6T1 NSBA124XDXV6T1 NSBA123JDXV6T1 NSBA115EDXV6T1 NSBA144WDXV6T1 | h _{FE} | 35 60 80 80 160 160 3.0 8.0 15 80 80 80 80 80 | 60 100 140 140 250 250 5.0 15 27 140 130 140 130 140 | - - - - - - - - - - - - - - | |
| Output Voltage (on) (V _{CC} = -5.0 V, V _B = -2.5 V, R _L = 1.0 kΩ) | NSBA114EDXV6T1 NSBA124EDXV6T1 NSBA114YDXV6T1 NSBA114TDXV6T1 NSBA143TDXV6T1 NSBA113EDXV6T1 NSBA123EDXV6T1 NSBA143EDXV6T1 NSBA143ZDXV6T1 NSBA124XDXV6T1 NSBA123JDXV6T1 (V _{CC} = -5.0 V, V _B = -3.5 V, R _L = 1.0 kΩ) (V _{CC} = -5.0 V, V _B = -5.5 V, R _L = 1.0 kΩ) (V _{CC} = -5.0 V, V _B = -4.0 V, R _L = 1.0 kΩ) | V _{OL} | - - - - - - - - - - - - - - - - - - - | - - - - - - - - - - - - - - - - - - - | -0.2 -0.2 -0.2 -0.2 -0.2 -0.2 -0.2 -0.2 -0.2 -0.2 -0.2 -0.2 -0.2 -0.2 -0.2 -0.2 -0.2 -0.2 -0.2 | Vdc |
| Output Voltage (off) (V _{CC} = -5.0 V, V _B = -0.5 V, R _L = 1.0 kΩ) (V _{CC} = -5.0 V, V _B = -0.05 V, R _L = 1.0 kΩ) (V _{CC} = -5.0 V, V _B = -0.25 V, R _L = 1.0 kΩ) | NSBA113EDXV6T1 NSBA114TDXV6T1 NSBA143TDXV6T1 NSBA123EDXV6T1 NSBA143ZDXV6T1 | V _{OH} | -4.9 | - | - | Vdc |
| Input Resistor | NSBA114EDXV6T1 NSBA124EDXV6T1 NSBA144EDXV6T1 NSBA114YDXV6T1 NSBA114TDXV6T1 NSBA143TDXV6T1 NSBA113EDXV6T1 NSBA123EDXV6T1 NSBA143EDXV6T1 NSBA143ZDXV6T1 NSBA124XDXV6T1 NSBA123JDXV6T1 NSBA115EDXV6T1 NSBA144WDXV6T1 | R ₁ | 7.0 15.4 32.9 7.0 7.0 3.3 0.7 1.5 3.3 3.3 15.4 1.54 70 32.9 | 10 22 47 10 10 4.7 1.0 2.2 4.7 4.7 22 2.2 100 47 | 13 28.6 61.1 13 13 6.1 1.3 2.9 6.1 6.1 28.6 2.86 130 61.1 | k Ω |
| Resistor Ratio | NSBA114EDXV6T1/NSBA124EDXV6T1/ NSBA144EDXV6T1/NSBA115EDXV6T1 NSBA114YDXV6T1 NSBA114TDXV6T1/NSBA143TDXV6T1 NSBA113EDXV6T1/NSBA123EDXV6T1/NSBA143EDXV6T1 NSBA143ZDXV6T1 NSBA124XDXV6T1 NSBA123JDXV6T1 NSBA144WDXV6T1 | R ₁ /R ₂ | 0.8 0.17 - 0.8 0.055 0.38 0.038 1.7 | 1.0 0.21 - 1.0 0.1 0.47 0.047 2.1 | 1.2 0.25 - 1.2 0.185 0.56 0.056 2.6 | |

2. New resistor combinations. Updated curves to follow in subsequent data sheets.
3. Pulse Test: Pulse Width < 300 μs, Duty Cycle < 2.0%

NSBA114EDXV6T1, NSBA114EDXV6T5

ALL NSBA114EDXV6T1 SERIES DEVICES

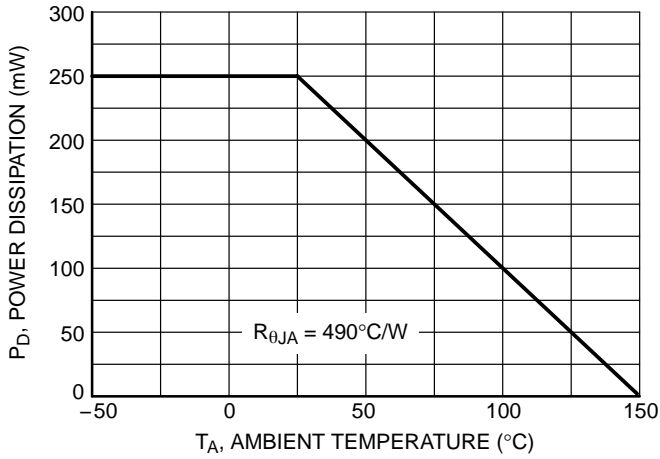


Figure 1. Derating Curve – ALL DEVICES

TYPICAL ELECTRICAL CHARACTERISTICS — NSBA114EDXV6T1

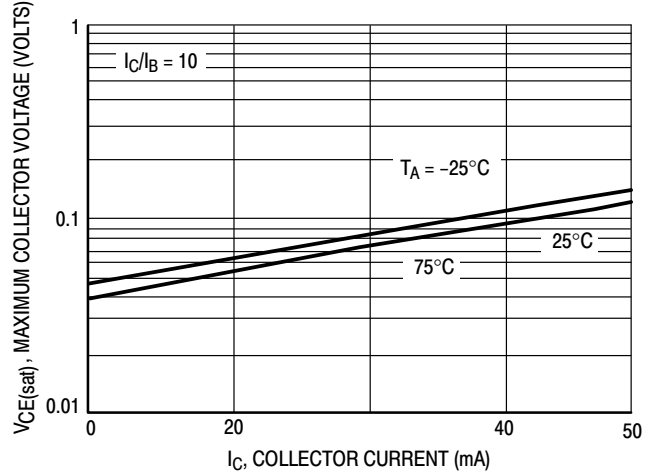


Figure 2. V_{CE(sat)} versus I_C

TYPICAL ELECTRICAL CHARACTERISTICS — NSBA114EDXV6T1

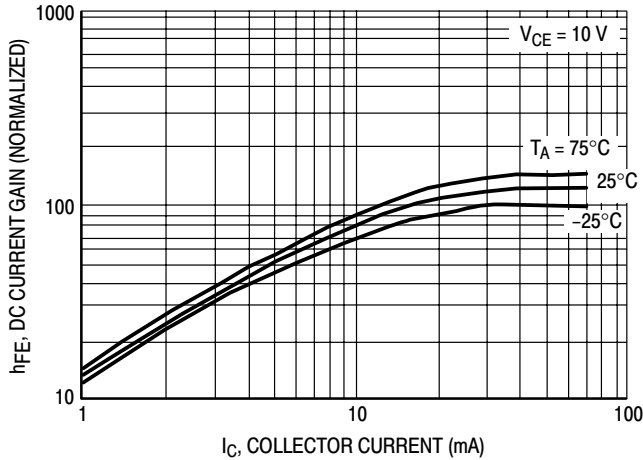


Figure 3. DC Current Gain

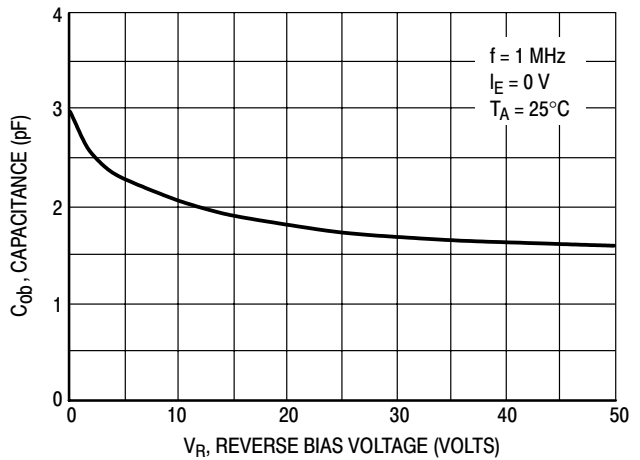


Figure 4. Output Capacitance

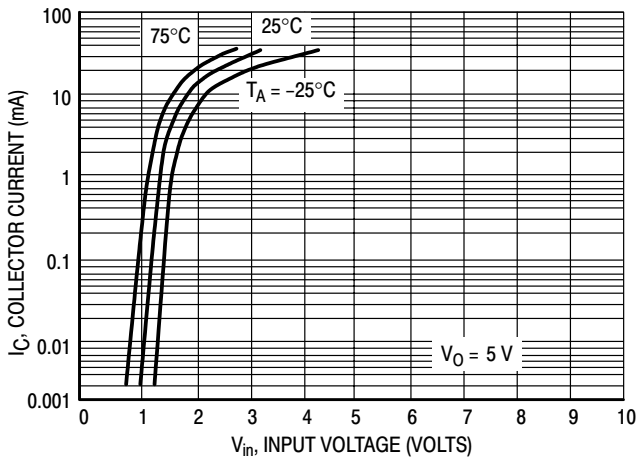


Figure 5. Output Current versus Input Voltage

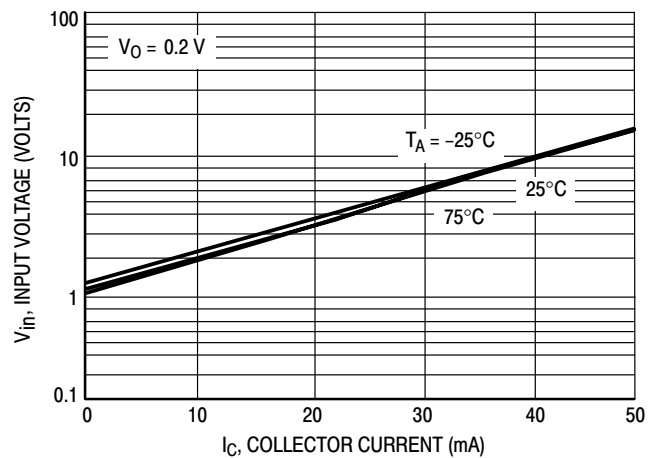


Figure 6. Input Voltage versus Output Current

NSBA114EDXV6T1, NSBA114EDXV6T5

TYPICAL ELECTRICAL CHARACTERISTICS — NSBA124EDXV6T1

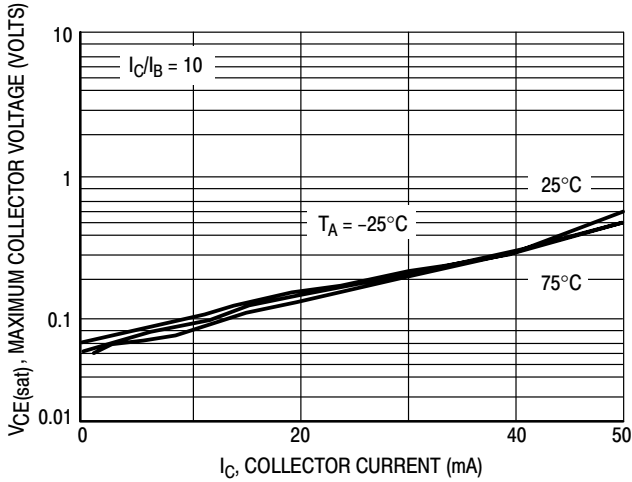


Figure 7. $V_{CE(sat)}$ versus I_C

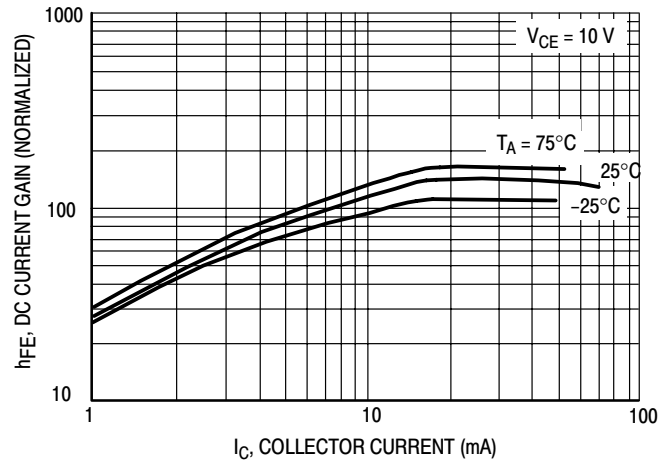


Figure 8. DC Current Gain

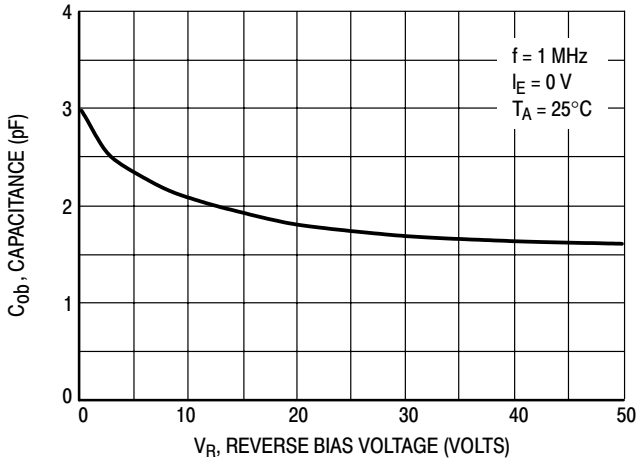


Figure 9. Output Capacitance

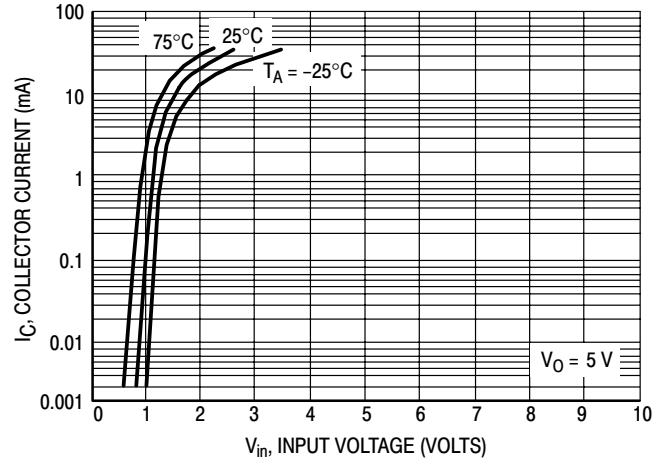


Figure 10. Output Current versus Input Voltage

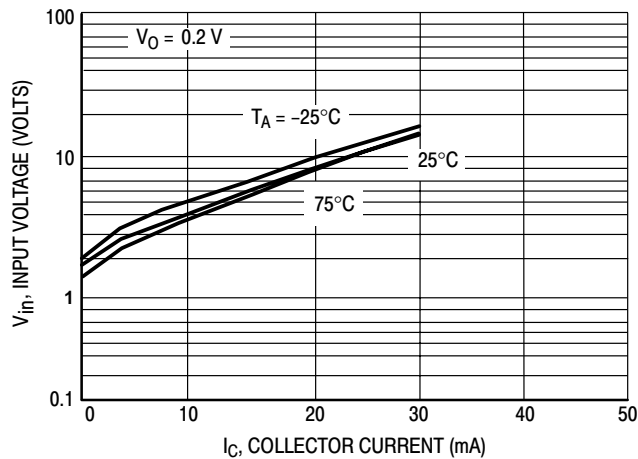


Figure 11. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS — NSBA114EDXV6T1

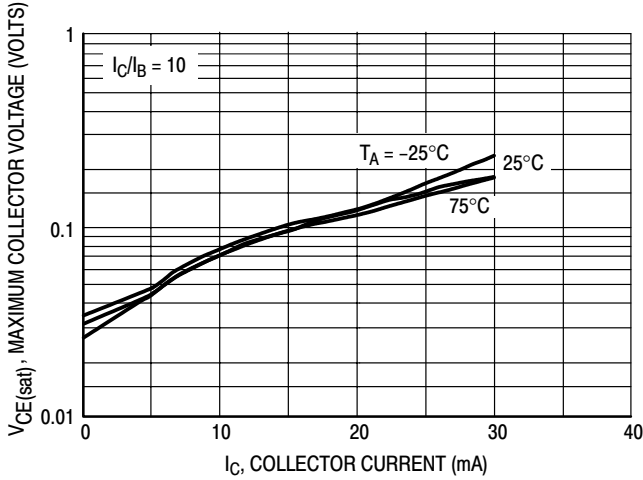


Figure 12. $V_{CE(sat)}$ versus I_C

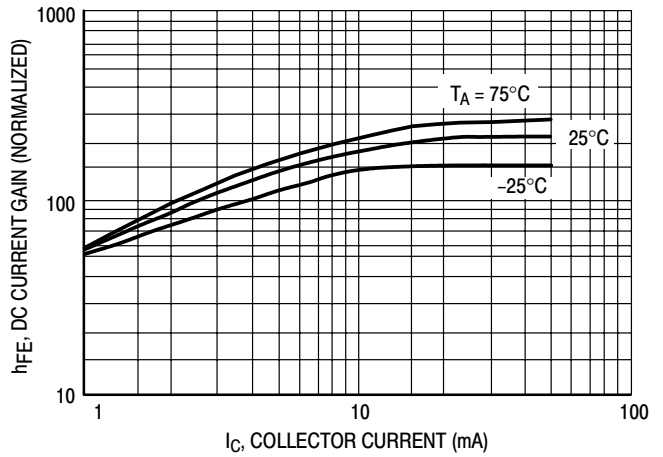


Figure 13. DC Current Gain

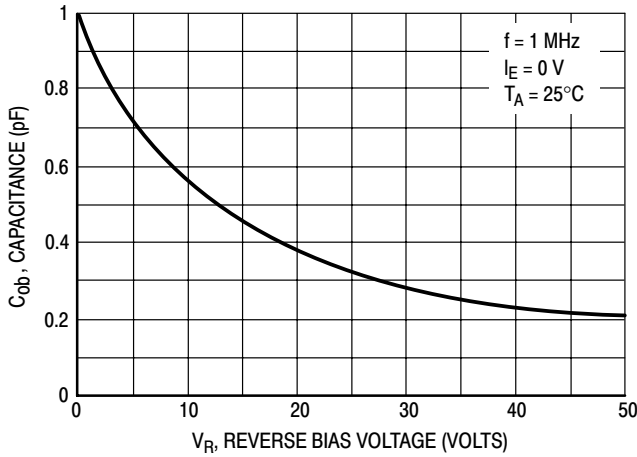


Figure 14. Output Capacitance

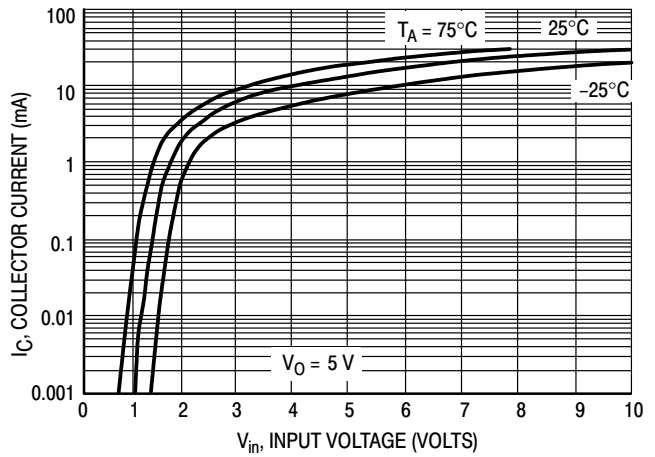


Figure 15. Output Current versus Input Voltage

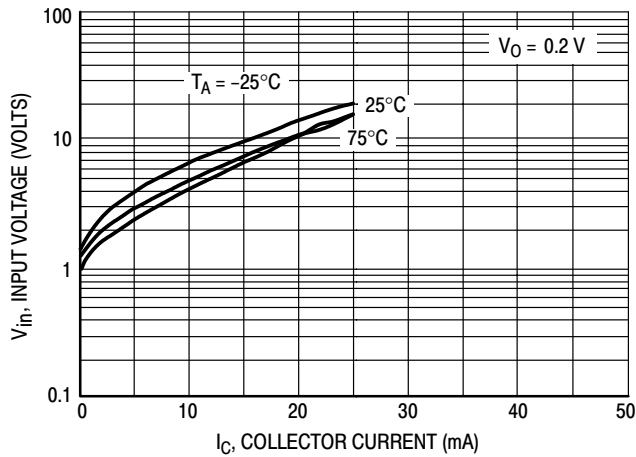


Figure 16. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS — NSBA114YDXV6T1

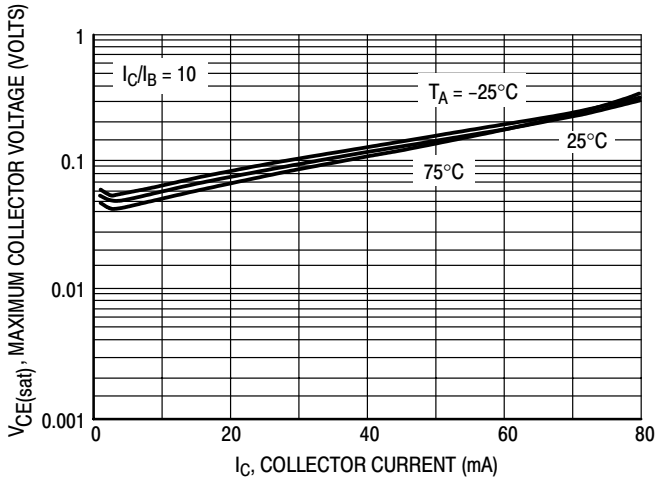


Figure 17. $V_{CE(sat)}$ versus I_C

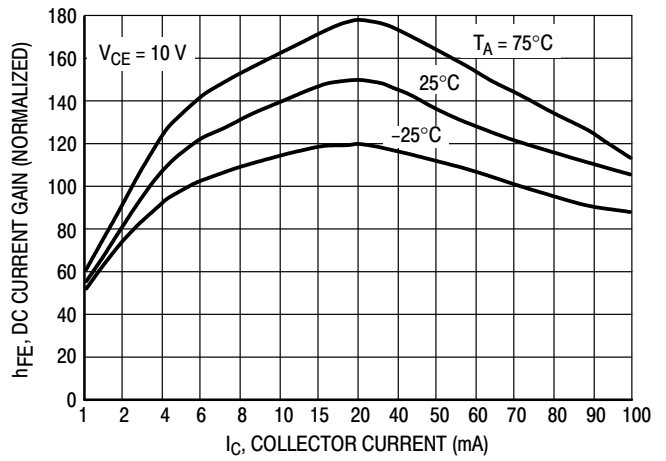


Figure 18. DC Current Gain

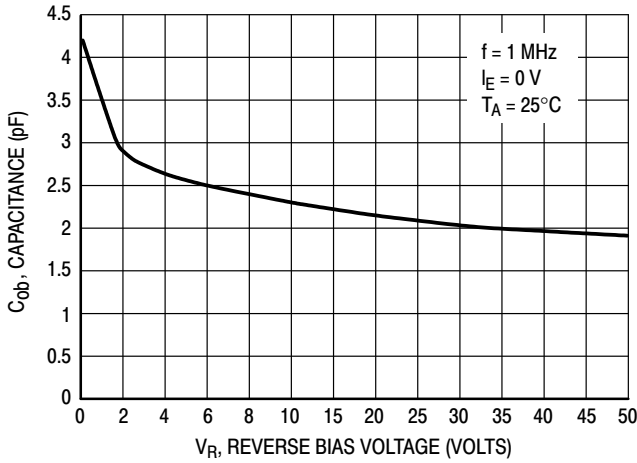


Figure 19. Output Capacitance

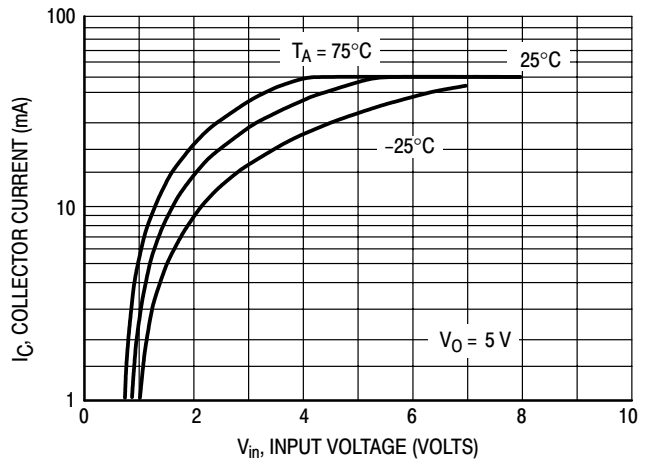


Figure 20. Output Current versus Input Voltage

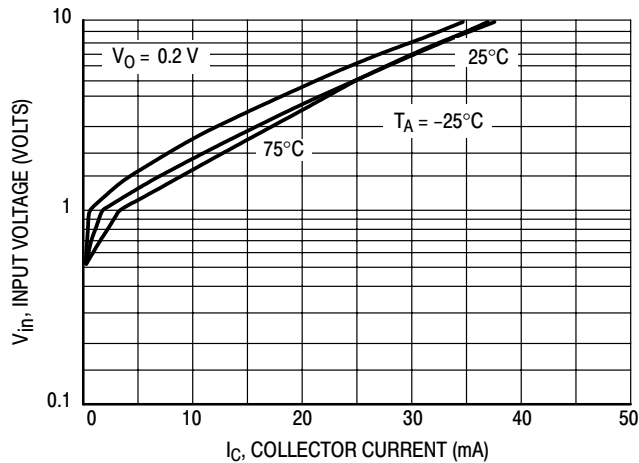


Figure 21. Input Voltage versus Output Current

NSBA114EDXV6T1, NSBA114EDXV6T5

TYPICAL ELECTRICAL CHARACTERISTICS — NSBA114TDXV6T1

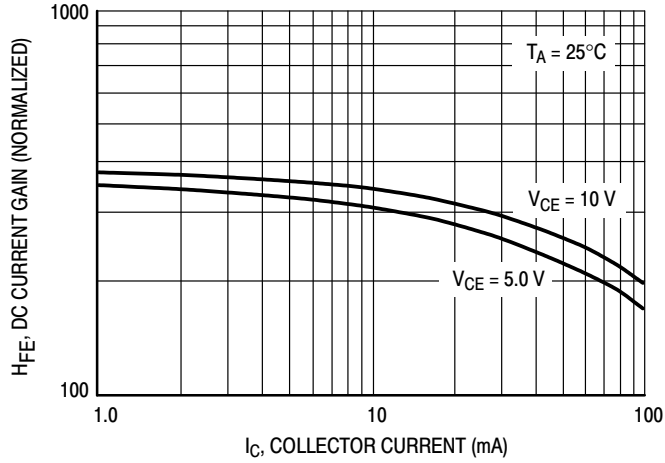


Figure 22. DC Current Gain

TYPICAL ELECTRICAL CHARACTERISTICS — NSBA143TDXV6T1

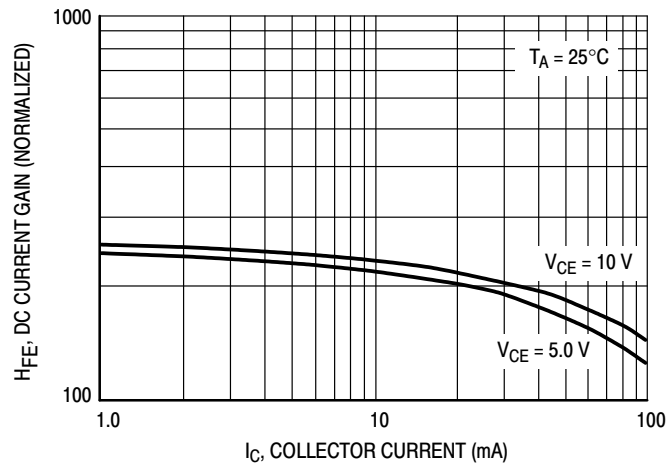


Figure 23. DC Current Gain

TYPICAL ELECTRICAL CHARACTERISTICS — NSBA115EDXV6T1

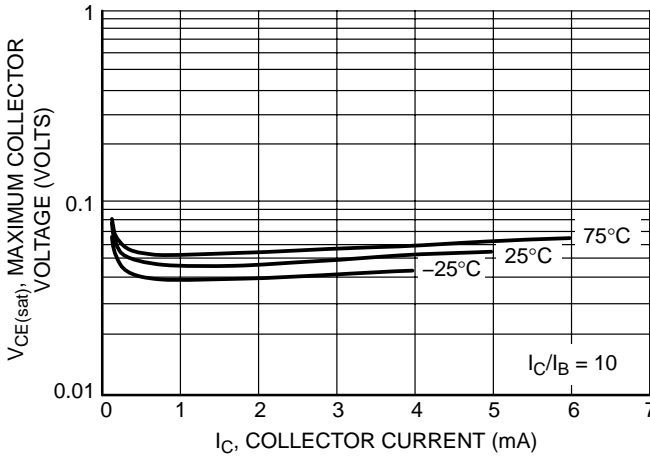


Figure 24. Maximum Collector Voltage versus Collector Current

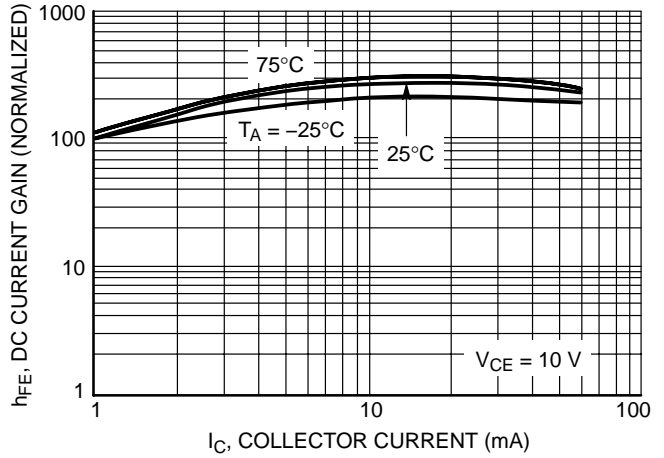


Figure 25. DC Current Gain

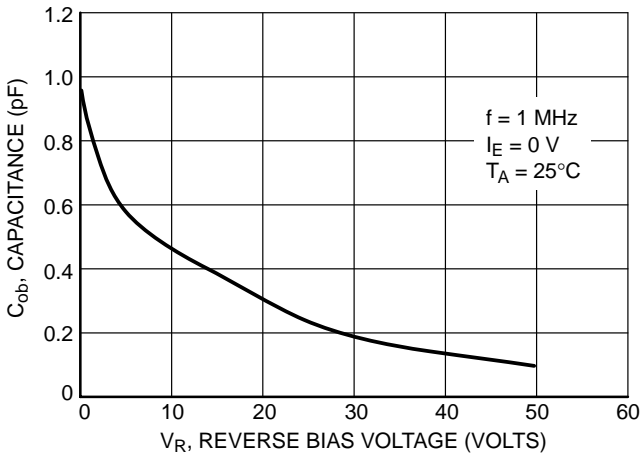


Figure 26. Output Capacitance

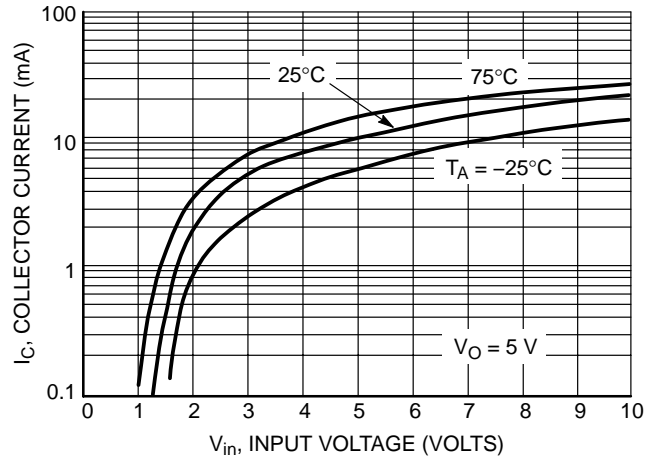


Figure 27. Output Current versus Input Voltage

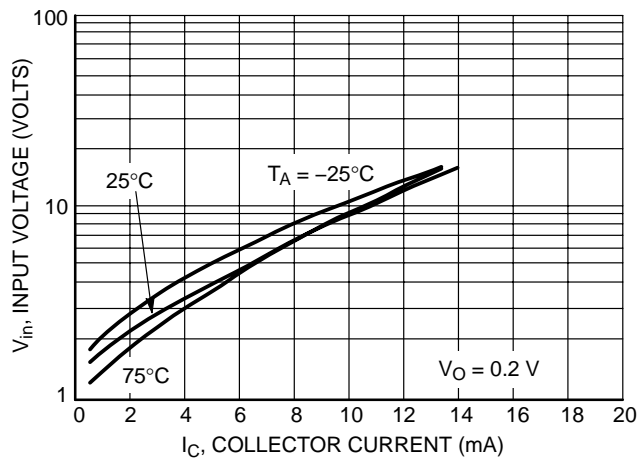


Figure 28. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS — NSBA144WDXV6T1

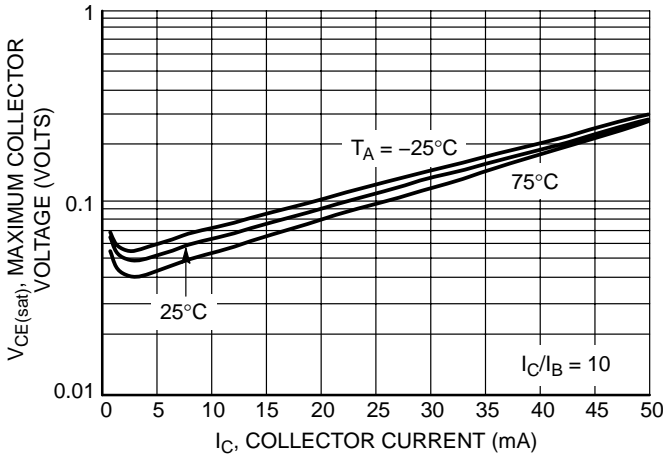


Figure 29. Maximum Collector Voltage versus Collector Current

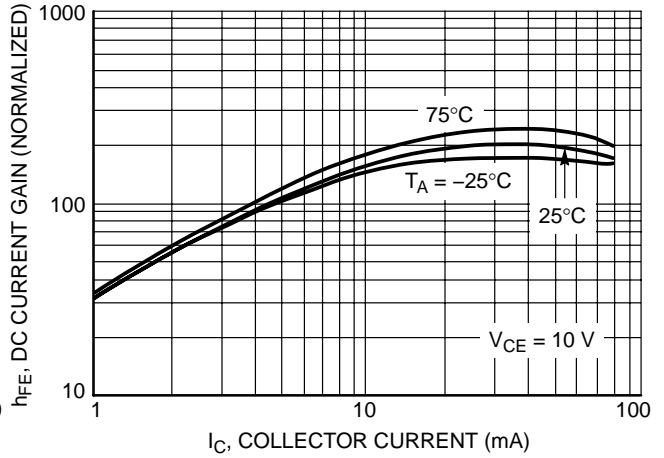


Figure 30. DC Current Gain

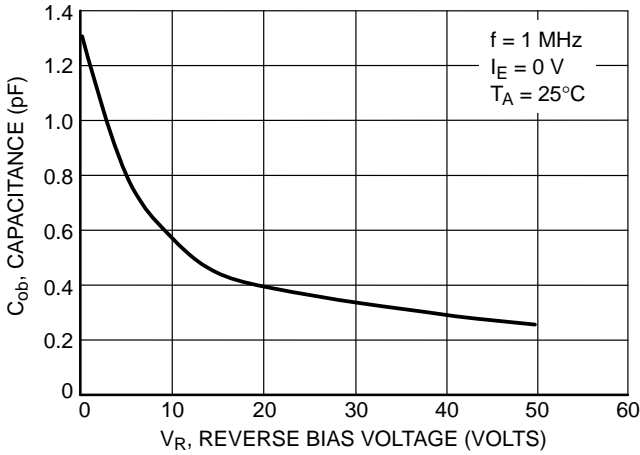


Figure 31. Output Capacitance

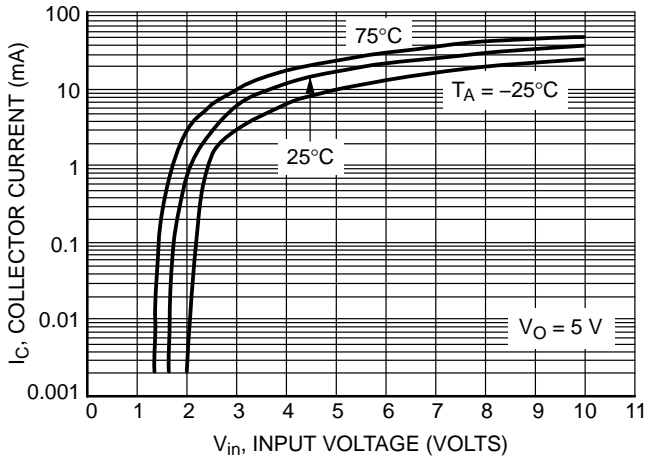


Figure 32. Output Current versus Input Voltage

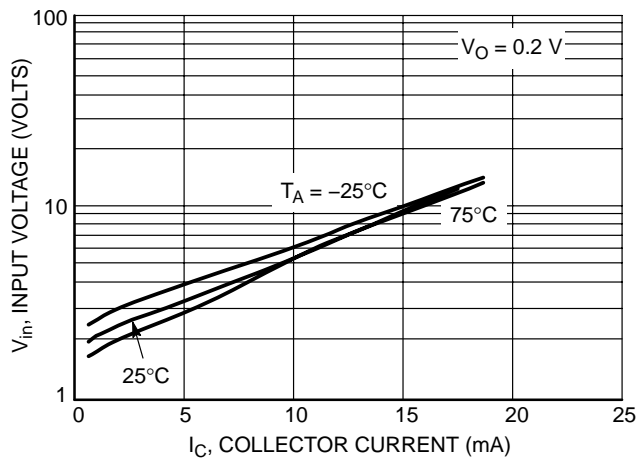
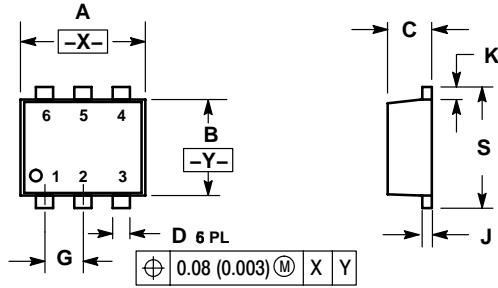


Figure 33. Input Voltage versus Output Current

NSBA114EDXV6T1, NSBA114EDXV6T5

PACKAGE DIMENSIONS

SOT-563, 6 LEAD
CASE 463A-01
ISSUE O



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

| DIM | MILLIMETERS | | INCHES | |
|-----|-------------|------|-----------|-------|
| | MIN | MAX | MIN | MAX |
| A | 1.50 | 1.70 | 0.059 | 0.067 |
| B | 1.10 | 1.30 | 0.043 | 0.051 |
| C | 0.50 | 0.60 | 0.020 | 0.024 |
| D | 0.17 | 0.27 | 0.007 | 0.011 |
| G | 0.50 BSC | | 0.020 BSC | |
| J | 0.08 | 0.18 | 0.003 | 0.007 |
| K | 0.10 | 0.30 | 0.004 | 0.012 |
| S | 1.50 | 1.70 | 0.059 | 0.067 |

STYLE 1:

- PIN 1. EMITTER 1
2. BASE 1
3. COLLECTOR 2
4. EMITTER 2
5. BASE 2
6. COLLECTOR 1

STYLE 2:

- PIN 1. EMITTER 1
2. EMITTER 2
3. BASE 2
4. COLLECTOR 2
5. BASE 1
6. COLLECTOR 1

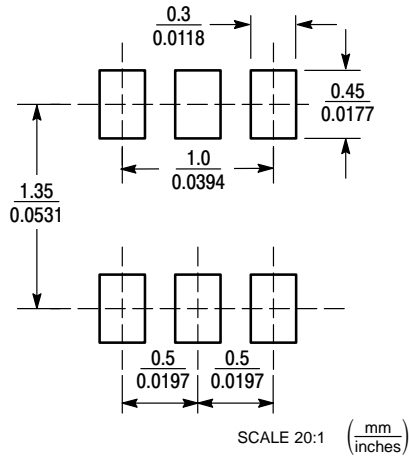
STYLE 3:

- PIN 1. CATHODE 1
2. CATHODE 1
3. ANODE/ANODE 2
4. CATHODE 2
5. CATHODE 2
6. ANODE/ANODE 1

STYLE 4:


- PIN 1. COLLECTOR
2. COLLECTOR
3. BASE
4. EMITTER
5. COLLECTOR
6. COLLECTOR

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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